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STAC4932B

Datasheet - production data

HF/VHF/UHF RF power N-channel MOSFET



Figure 1. Pin connection



Features

- Excellent thermal stability
- Common source push-pull configuration
- P_{OUT} = 1000 W min. (1200 W typ.) with 26 dB gain @ 123 MHz
- Pulse conditions: 1 msec 10%
- In compliance with the 2002/95/EC European directive
- ST air-cavity STAC[®] packaging technology

Description

The STAC4932B is an N-channel MOS field-effect RF power transistor. It is intended for 100 V pulse applications up to 250 MHz. This device is suitable for use in industrial, scientific and medical applications. The STAC4932B benefits from the latest generation of efficient, patent-pending STAC[®] package technology.

Table 1. Device summary

Order code	Marking	Package	Packaging
STAC4932B	STAC4932 ⁽¹⁾	STAC244B	Plastic tray

1. For more details please refer to Chapter 6: Marking, packing and shipping specifications.

This is information on a product in full production.

Contents

1	Electrical data
	1.1 Maximum ratings
	1.2 Thermal data
2	Electrical characteristics
	2.1 Static
	2.2 Dynamic
3	Impedance
4	Typical performance
5	Package mechanical data 9
6	Marking, packing and shipping specifications
7	Revision history



1 Electrical data

1.1 Maximum ratings

Symbol	Parameter	Value	Unit		
V _{(BR)DSS} ⁽¹⁾	Drain source voltage	200	V		
V_{DGR}	Drain-gate voltage (R_{GS} = 1 M Ω)	200	V		
V _{GS}	Gate-source voltage	±20	V		
TJ	Max. operating junction temperature	200	°C		
T _{STG}	Storage temperature	-65 to +150	°C		
4 T 450.00					

Table 2. Absolute maximum ratings (T_{CASE} = 25 °C)

1. T_J = 150 °C

1.2 Thermal data

Table 3. Thermal data (1 msec - 10%)

Symbol	Parameter	Value	Unit
R _{thJC}	Junction - case thermal resistance	0.075	°C/W



2 Electrical characteristics

T_{CASE} = +25 °C

2.1 Static

Table 4. Static (per side)							
Symbol		Test conditions		Min.	Тур.	Max.	Unit
V _{(BR)DSS} ⁽¹⁾	$V_{GS} = 0 V$	I _{DS} = 100 mA		200	250		V
I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 100 V				1	mA
I _{GSS}	$V_{GS} = 20 V$	$V_{DS} = 0 V$				250	nA
V _{TH}	I _D = 250 mA			2.0		4.0	V
V _{DS(ON)}	V _{GS} = 10 V	I _D = 10 A				3.6	V
G _{FS}	V _{DS} = 10 V	I _D = 2.5 A			6		S
C _{ISS}	$V_{GS} = 0 V$	V _{DS} = 100 V	f = 1 MHz		570		pF
C _{OSS}	$V_{GS} = 0 V$	V _{DS} = 100 V	f = 1 MHz		134		pF
C _{RSS}	$V_{GS} = 0 V$	V _{DS} = 100 V	f = 1 MHz		8		pF

Table 4. Static (per side)

1. T_J = 150 °C

2.2 Dynamic

Table 5. Pulse / 1 msec - 10%	
	т

Symbol	Test conditions	Min.	Тур.	Max.	Unit
P _{OUT}	V _{DD} = 100 V, I _{DQ} = 2 x 250 mA, f = 123 MHz	1000	1200	-	W
h _D	V _{DD} = 100 V, I _{DQ} = 2 x 250 mA, P _{OUT} = 1000 W, f = 123 MHz		60	-	%
Gain	V _{DD} = 100 V, I _{DQ} = 2 x 250 mA, P _{OUT} = 1000 W, f = 123 MHz		26	-	dB



3 Impedance



Table 6. Impedance data

Freq. (MHz)	Ζ_{IN} (Ω)	Ζ_{DL}(Ω)
123 MHz (pulsed)	1.3 - j 2.8	7.7 - j 9.4

Note: Measured gate-to-gate and drain-to-drain, respectively.



4 Typical performance



Figure 3. Maximum safe operating area









Figure 5. Transient thermal model







DocID17153 Rev 7



Figure 7. Efficiency vs. output power



5 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.



Figure 8. Package dimensions



Table 7. STAC244D mechanical uala				
Dim		mm		
Din.	Min.	Тур.	Max.	
А	5.08		5.59	
A1	4.32		4.83	
В	4.32		5.33	
С	9.65		9.91	
D	17.78		18.08	
E	33.88		34.19	
F	0.10		0.15	
G		1.02		
Н	1.45		1.70	
I	4.83		5.33	
J	9.27		9.52	
К	27.69		28.19	
L	3.12	3.23	3.33	
М	3.35	3.45	3.56	

Table 7. STAC244B mechanical data



6 Marking, packing and shipping specifications

Order code	Packaging	Pcs per tray	Dry pack humidity	Lot code
STAC4932B	Tray	20	< 10%	Not mixed

Figure 9. Marking layout



Table 9. Marking specifications

Symbol	Description
CZ	Assembly plant
ZZZ	Last 3 digits of diffusion lot
VY	Diffusion plant
MAR	Country of origin
CZ	Test and finishing plant
у	Assembly year
ХХ	Assembly week



7 Revision history

Date	Revision	Changes
19-Feb-2010	1	First release.
26-May-2010	2	Document status promoted from preliminary data to datasheet.
03-Aug-2010	3	Updated description on cover page and Table 3.
03-Sep-2010	4	Updated figures: <i>3</i> , <i>4</i> and <i>5</i> .
12-Sep-2011	5	Inserted new <i>Section 6: Marking, packing and shipping specifications.</i> Updated <i>Table 6.</i> Minor text changes.
01-Jul-2013	6	Modified pin labeling in <i>Figure 1: Pin connection</i> . Modified document title. Minor text corrections throughout document.
27-Jan-2014	7	Modified pin labeling in <i>Figure 1: Pin connection</i> .

Table 10. Document revision history

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DocID17153 Rev 7